

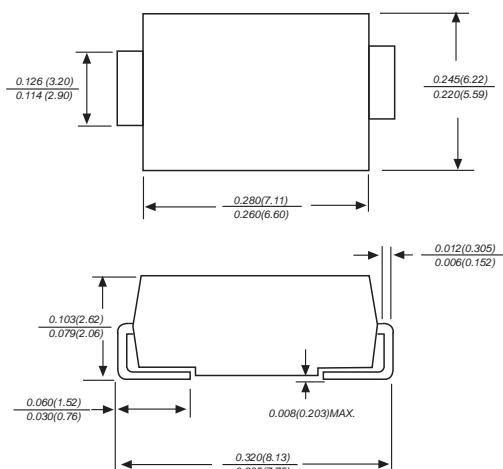


MURS405 THRU MURS460

SURFACE MOUNT SUPER FAST RECTIFIER

Reverse Voltage - 50 to 600 Volts Forward Current - 4.0 Amperes

DO-214AB/SMC



Dimensions in inches and (millimeters)

FEATURES

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Low reverse leakage
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 250°C/10 seconds at terminals
- Glass passivated chip junction

MECHANICAL DATA

Case : JEDEC DO-214AB molded plastic body over passivated chip

Terminals : Solder plated, solderable per MIL-STD-750, Method 2026

Polarity : Color band denotes cathode end

Mounting Position : Any

Weight : 0.007 ounce, 0.25grams

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate by 20%.

MDD Catalog Number		MURS 405	MURS 410	MURS 415	MURS 420	MURS 430	MURS 440	MURS 450	MURS 460	UNITS						
Maximum recurrent peak reverse voltage	V_{RRM}	50	100	150	200	300	400	500	600	V						
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	350	420	V						
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	500	600	V						
Maximum average forward rectified current @ $T_A=75^\circ\text{C}$	$I_{F(AV)}$	4.0								A						
Peak forward surge current 8.3ms single half-sine-wave superimposed on rated load @ $T_J=125^\circ\text{C}$	I_{FSM}	125.0								A						
Maximum instantaneous forward voltage @ 4.0A	V_F	0.89		1.28						V						
Maximum reverse current @ $T_A=25^\circ\text{C}$ at rated DC blocking voltage @ $T_A=125^\circ\text{C}$	I_R	10.0 100.0								μA						
Maximum reverse recovery time (Note1)	t_{rr}	25		50						ns						
Typical junction capacitance (Note2)	C_J	95								pF						
Typical thermal resistance (Note3)	$R_{\theta JA}$	20								$^\circ\text{C}/\text{W}$						
Operating junction temperature range	T_J	- 55 to + 150								$^\circ\text{C}$						
Storage temperature range	T_{STG}	- 55 to + 150								$^\circ\text{C}$						

NOTE: 1. Measured with $I_F=0.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=0.25\text{A}$.

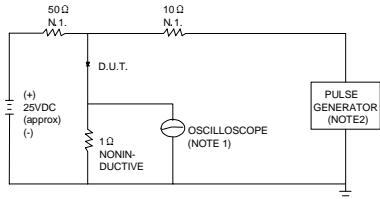
2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

3. Thermal resistance from junction to ambient.

MDD ELECTRONIC

RATINGS AND CHARACTERISTIC CURVES MURS405 THRU MURS460

FIG.1 – TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



NOTES:
1.RISE TIME = 7ns MAX INPUT IMPEDANCE = $1M\Omega$. 22pF.
2.RISE TIME = 10ns MAX SOURCE IMPEDANCE = 50 Ω.

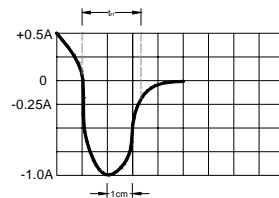


FIG.2 – TYPICAL FORWARD CHARACTERISTIC

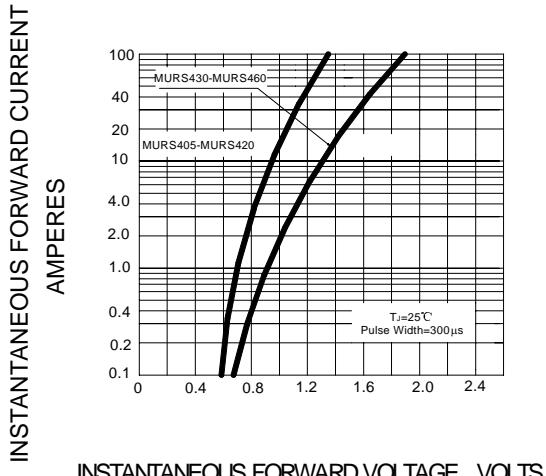


FIG.3 – TYPICAL REVERSE CHARACTERISTIC

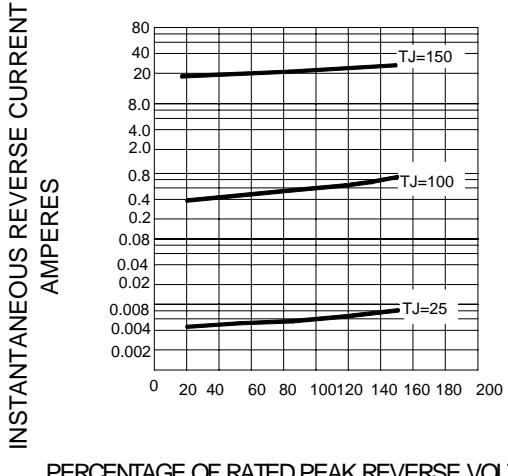


FIG.4 – TYPICAL JUNCTION CAPACITANCE

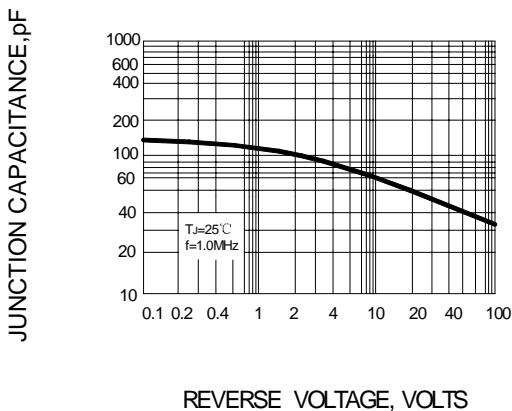
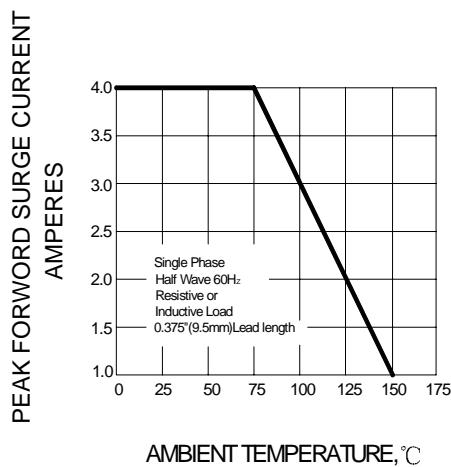


FIG.5 – FORWARD DERATING CURVE



MDD ELECTRONIC